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**(54) THERMOSETTING RESIN COMPOSITION AND ITS HARDENED MATTER**

(57) Abstract:

**PROBLEM TO BE SOLVED:** To provide a thermosetting resin composition having dihydrobenzoxazine ring in which moldability and setting property are improved without lowering various properties such as mechanical

property, and its hardened matter.

**SOLUTION:** The thermosetting resin composition which consists of (A) a thermosetting resin having dihydrobenzoxazine ring, (B) a phenol resin and (C) a phosphorus accelerator, and the hardened matter are provided.

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